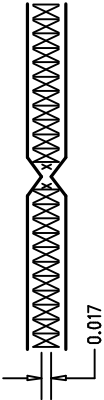


REVISIONS			
REV	DESCRIPTION	APPR	DATE

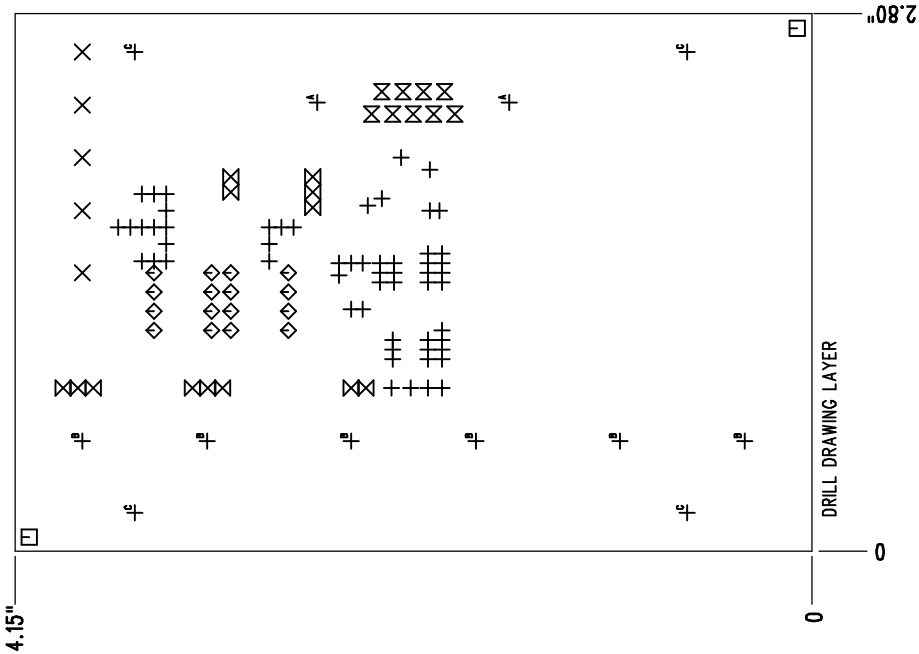
NOTES : Unless Otherwise Specified


1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD
THICKNESS .062 +/- .006 TOTAL OF 2 LAYERS.
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
ELECTRODEPOSITED TIN-LEAD COMPOSITION
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC).
3. SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT.
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK.
5. FILL UP VIAS WITH SOLDER.
6. ALL DIMENSIONS ARE IN INCHES.
7. SCORING:



SIZE	QTY	SYM	PLTD
20	58	+	PLTD
94	5	X	PLTD
70	2	□	NPLTD
35	16	◇	PLTD
40	13	⊗	PLTD
37	9	⊠	PLTD
120	2	A	PLTD
205	6	B	PLTD
125	4	C	PLTD

FAB DRAWING



APPROVALS				LINEAR TECHNOLOGY		1630 McCarthy Blvd. Milpitas, CA 95035 PH: (408)432-1900		
DRAWN	INIT	DATE	TITLE: LTC2415 Differential Input 24-Bit ADC with 2X Output Rate				SIZE A	REV. A
CHECK								
DESIGN	JUNE WU	10/30/00						
ENGR	M. Moyes	10/30/00						
SCALE = NONE			DC382A LTC2415CGN			SHT 1 of 1		